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PATENT
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EX THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of:
Cheung, et al.

Serial No.: 09/609,347

Confirmation No.:

Filed: July 5, 2000

For: Apparatus for Electro-Chemical Deposition of Copper Metallization With the Capability of In-Situ Thermal Annealing

Group Art Unit: 1741

Examiner: Unknown

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Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

CERTIFICATE OF MAILING
37 CFR 1.8

I hereby certify that this correspondence is being deposited on August 21, 2001 with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

8-21-01

Date _____

Signature

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

The Applicants, and the Attorney who signs below on the basis of the information supplied by the inventor and the information in his file, submit herewith patents, publications, or other information of which they are aware, which may be material to the examination of this application and in respect of which there may be a duty to disclose in accordance with 37 CFR § 1.56.

While the information submitted in this Supplemental Information Disclosure Statement may be material pursuant to 37 CFR § 1.56, it is not intended to constitute an admission that any patent, publication, or other information referred to therein is prior art for this invention unless specifically designated as such.

In accordance with 37 CFR § 1.97, this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or that no other possibly material information as defined under 37 CFR § 1.56(a) exists.

The patents and/or publications submitted herewith are set forth on the attached Form PTO-1449.

Applicants certify that all references submitted with this disclosure were cited in a communication from a foreign patent office dated May 23, 2001, which communication is enclosed, not more than three months prior to the filing of this Supplemental Information Disclosure Statement.

~~If the sum of \$180.00 is due under 37 CFR § 1.17(p) pursuant to § 1.97, the~~ Commissioner is hereby authorized to charge this fee, and any other fee necessary to make this submission timely, to the Deposit Account No. 20-0782/APPM/3421C1/KMT.

Respectfully submitted,



Phong D. Nguyen
Registration No. 43,833
THOMASON, MOSER & PATTERSON, L.L.P.
3040 Post Oak Blvd., Suite 1500
Houston, TX 77056
Telephone: (713) 623-4844
Facsimile: (713) 623-4846
Attorney for Applicant(s)